

FMP60N079S2HF

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FUJI POWER MOSFET

Super J MOS[®] S2 series

N-Channel enhancement mode power MOSFET

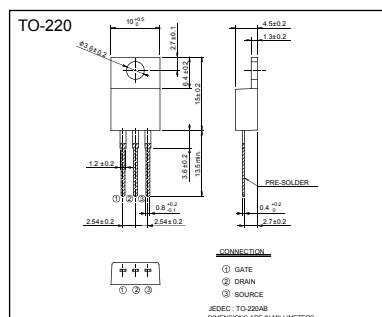
■ Features

Pb-free lead terminal
RoHS compliant
uses Halogen-free molding compound

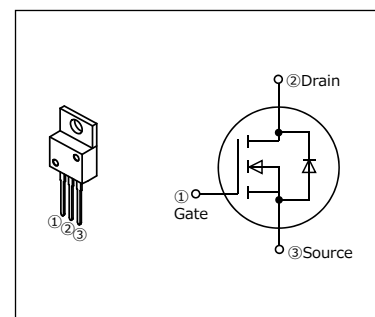
■ Applications

For switching

■ Outline Drawings [mm]



■ Equivalent circuit schematic



■ Absolute Maximum Ratings at $T_v=25^{\circ}\text{C}$ (unless otherwise specified)

Parameter	Symbol	Characteristics	Unit	Remarks
Drain-Source Voltage	V_{DS}	600	V	
	V_{DSX}	600	V	$V_{GS}=-30V$
Continuous Drain Current	I_D	47.9	A	$T_{vj}=25^{\circ}C$ Note*1,2
		30.3	A	$T_{vj}=100^{\circ}C$ Note*1,2
Pulsed Drain Current	I_{DP}	148	A	Note *2
Gate-Source Voltage	V_{GS}	± 30	V	
Non-Repetitive Maximum Avalanche Current	I_{AS}	5.5	A	Note *3
Non-Repetitive Maximum Avalanche Energy	E_{AS}	1177	mJ	Note *4
Maximum Drain-Source dV/dt	d V_{DS} /dt	50	V/ns	$V_{DS} \leq 600V$
Continuous Diode Forward Current	I_{SD}	47.9	A	$T_{vj}=25^{\circ}C$ Note*1,2
		30.3	A	$T_{vj}=100^{\circ}C$ Note*1,2
Pulsed Diode Forward Current	I_{SDP}	148	A	Note 2
Peak Diode Recovery dV/dt	dV/dt	15	V/ns	Note *5
Peak Diode Recovery -di/dt	-di/dt	100	A/ μs	Note *6
Maximum Power Dissipation	P_D	2.02	W	$T_a=25^{\circ}C$
		270		$T_{vj}=25^{\circ}C$
Operating and Storage Temperature range	T_{ch}	150	$^{\circ}C$	
	T_{stg}	-55 to +150	$^{\circ}C$	

Note *1 : Maximum duty cycle $D=0.6$

Note *2 : Limited by maximum channel temperature.

Note *3 : $T_{ch} \leq 150^{\circ}\text{C}$. See Fig.1 and Fig.2

Note *4 : Starting $T_{ch}=25^{\circ}\text{C}$, $I_{AS}=3.3\text{A}$, $L=198\text{mH}$, $V_{DD}=60\text{V}$, $R_G=50\Omega$, See Fig.1 and Fig.2

E_{AS} limited by maximum channel temperature and avalanche current.

Note *5: $I_{SD} \leq 37.1A$, $-di/dt \leq 100A/\mu s$, $V_{DS\ peak} \leq 600V$, $T_{ch} \leq 150^{\circ}C$.

Note *6: $I_{SD} \leq 37.1A$, $dV/dt \leq 15V/ns$, $V_{DS\ peak} \leq 600V$, $T_{ch} \leq 150^{\circ}C$

■ Electrical Characteristics at $T_{vj}=25^{\circ}\text{C}$ (unless otherwise specified)

• Static Ratings

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Drain-Source Breakdown Voltage	BV_{DSS}	$V_{GS}=0V$ $I_D=250\mu A$	600	-	-	V
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}$ $I_D=1.95mA$	3.5	4.0	4.5	V
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS}=600V$ $V_{GS}=0V$ $T_{ch}=25^{\circ}\text{C}$	-	-	25	μA
		$V_{DS}=480V$ $V_{GS}=0V$ $T_{ch}=125^{\circ}\text{C}$	-	-	250	
Gate-Source Leakage Current	I_{GSS}	$V_{DS}=0V$ $V_{GS}=\pm 30V$	-	10	100	nA
Drain-Source On-State Resistance	$R_{DS(on)}$	$V_{GS}=10V$ $I_D=18.6A$	-	0.071	0.079	Ω
Gate resistance	R_G	f=1MHz, open drain	-	7.2	-	Ω

• Dynamic Ratings

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Forward Transconductance	g_{fs}	$V_{DS}=25V$ $I_D=18.6A$	12.2	24.5	-	S
Input Capacitance	C_{iss}	$V_{DS}=400V$	-	2030	-	pF
Output Capacitance	C_{oss}	$V_{GS}=0V$	-	67	-	
Reverse Transfer Capacitance	C_{rss}	f=250kHz	-	8.7	-	
Effective output capacitance, energy related (Note *7)	$C_{o(er)}$	$V_{DS}=0\ldots 400V$ $V_{GS}=0V$	-	158	-	pF
Effective output capacitance, time related (Note *8)	$C_{o(tr)}$	$V_{DS}=0\ldots 400V$ $V_{GS}=0V$ $I_D=\text{constant}$	-	633	-	
Turn-On Time	$t_{d(on)}$	$V_{DD}=400V, V_{GS}=10V$ $I_D=18.6A,$ $R_G=12\Omega$	-	28	-	ns
	t_r		-	98	-	
Turn-Off Time	$t_{d(off)}$	See Fig.3 and Fig.4	-	140	-	
	t_f		-	26	-	
Total Gate Charge	Q_G	$V_{DD}=400V, V_{GS}=10V$ $I_D=37.1A$ See Fig.5	-	80	-	nC
Gate-Source Charge	Q_{GS}		-	29	-	
Gate-Drain Charge	Q_{GD}		-	34	-	
Drain-Source crossover Charge	Q_{SW}		-	18	-	

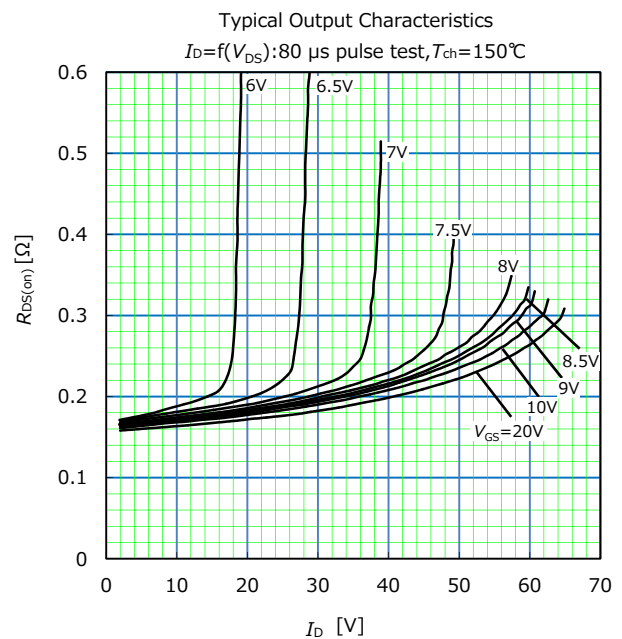
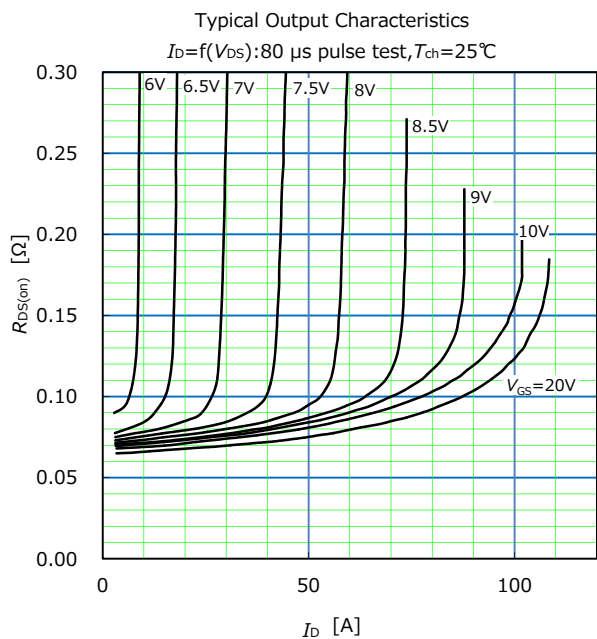
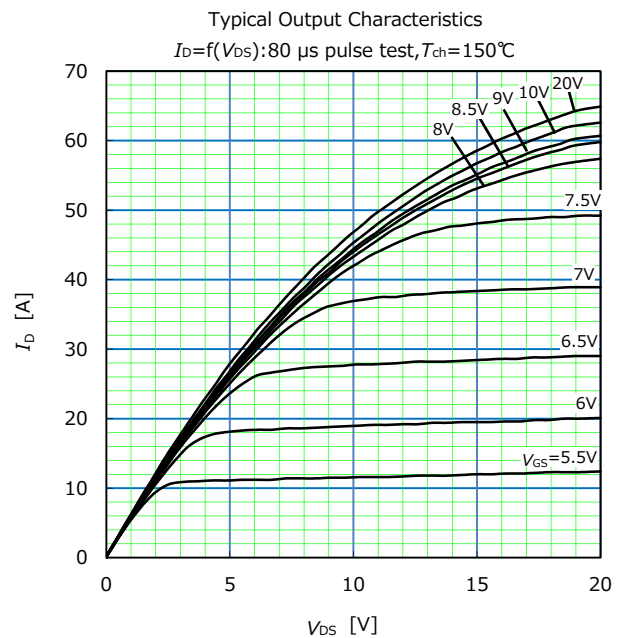
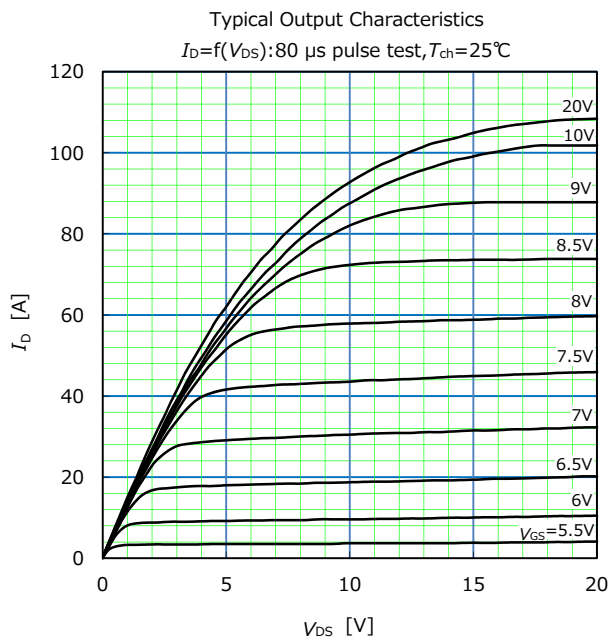
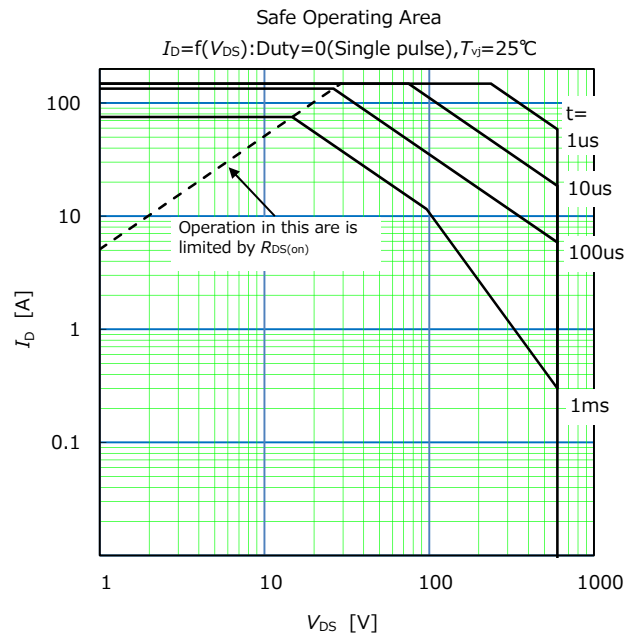
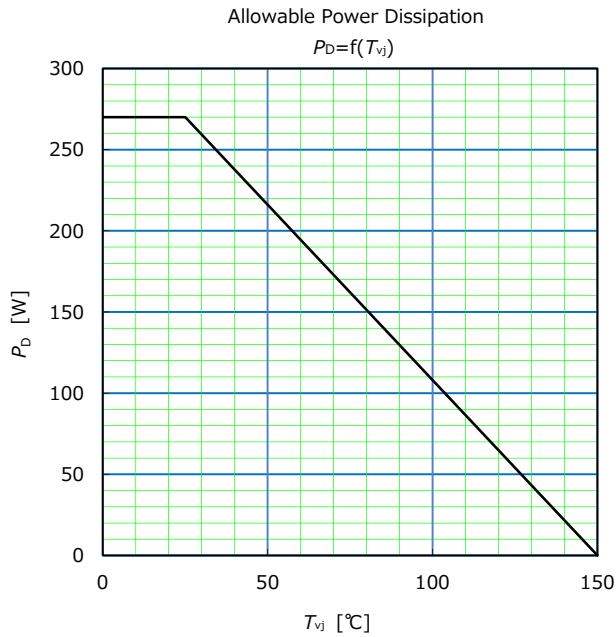
Note *7 : $C_{o(er)}$ is a fixed capacitance that gives the same stored energy as C_{oss} while V_{DS} is rising from 0 to 400V.Note *8 : $C_{o(tr)}$ is a fixed capacitance that gives the same charging times as C_{oss} while V_{DS} is rising from 0 to 400V.

• Reverse Diode

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Diode Forward On-Voltage	V_{SD}	$I_{SD}=37.1A, V_{GS}=0V$ $T_{ch}=25^{\circ}\text{C}$	-	0.90	1.35	V
Reverse Recovery Time	t_{rr}	$V_{DD}=400V, I_{SD}=37.1A$ -di/dt=100A/ μs $T_{ch}=25^{\circ}\text{C}$ See Fig.6 and Fig.7	-	380	-	ns
Reverse Recovery Charge	Q_{rr}		-	6.6	-	μC
Peak Reverse Recovery Current	I_{rp}		-	34	-	A

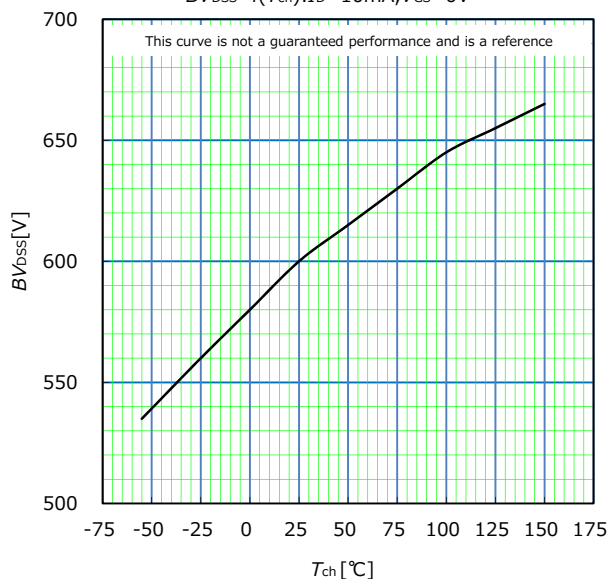
■ Thermal Resistance

Parameter	Symbol	Min.	Typ.	Max.	Unit
Channel to Case	$R_{th(ch-c)}$	-	-	0.463	$^{\circ}\text{C/W}$
Channel to Ambient	$R_{th(ch-a)}$	-	-	62	$^{\circ}\text{C/W}$



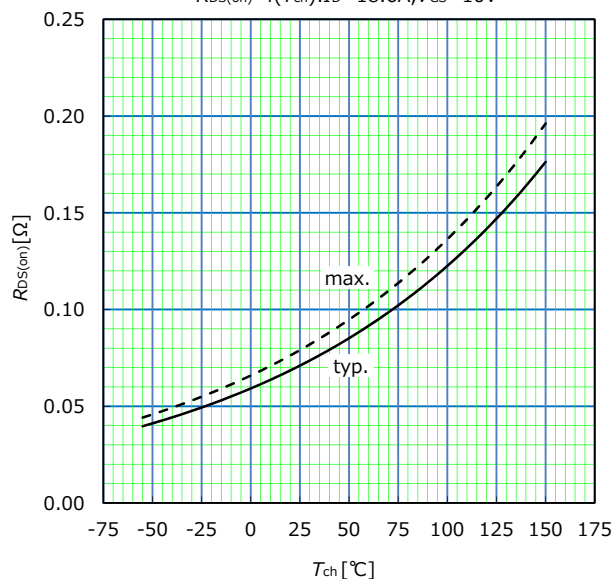
Drain-Source Breakdown Voltage

$$BV_{DS} = f(T_{ch}) : I_D = 10\text{mA}, V_{GS} = 0\text{V}$$

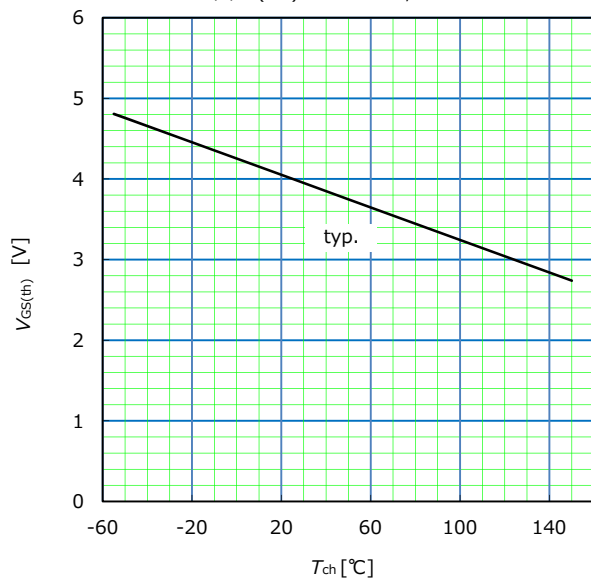


Drain-Source On-state Resistance

$$R_{DS(on)} = f(T_{ch}) : I_D = 18.6\text{A}, V_{GS} = 10\text{V}$$

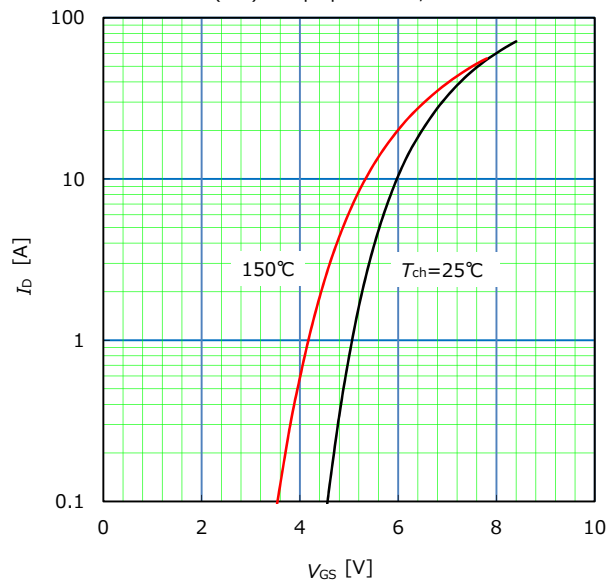
Gate Threshold Voltage vs. T_{ch}

$$V_{GS(th)} = f(T_{ch}) : V_{DS} = V_{GS}, I_D = 1.95\text{mA}$$



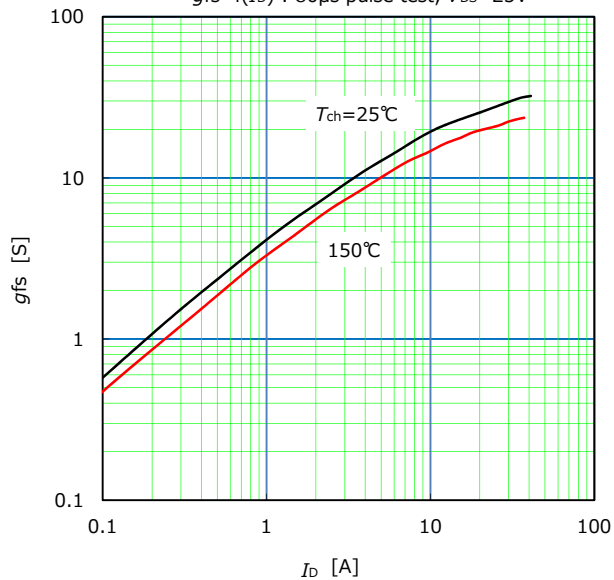
Typical Transfer Characteristic

$$I_D = f(V_{GS}) : 80\mu\text{s pulse test}, V_{DS} = 25\text{V}$$



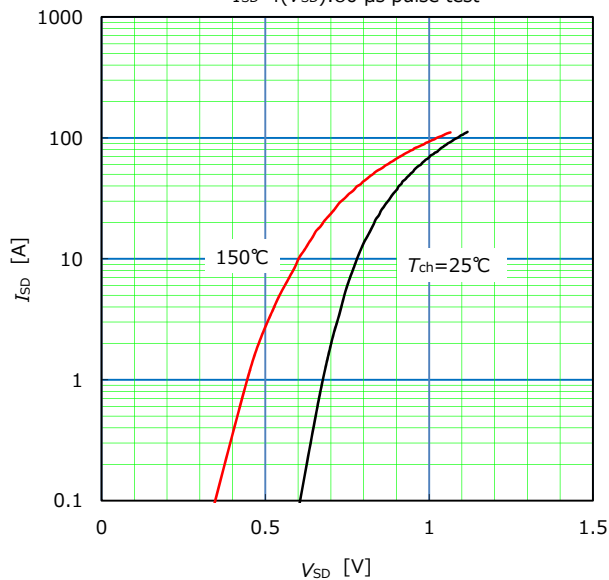
Typical Transconductance

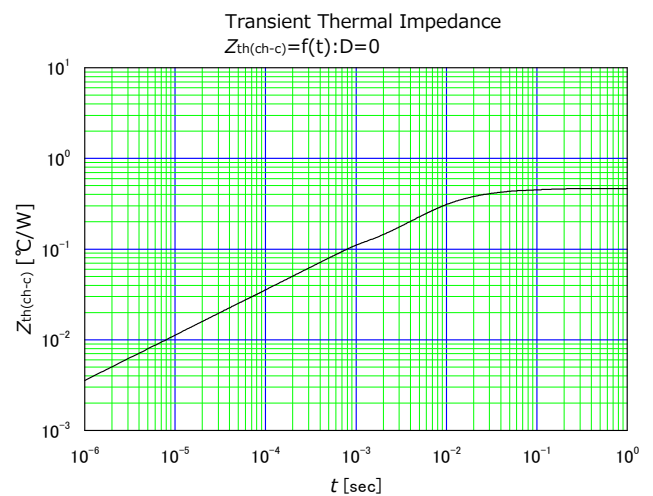
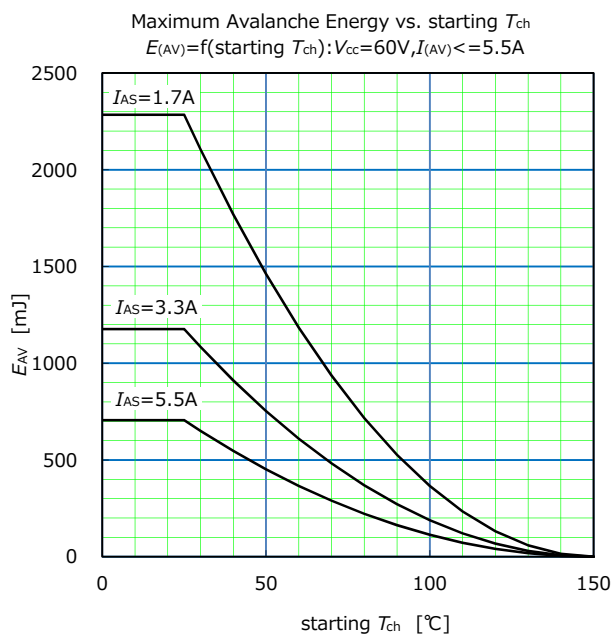
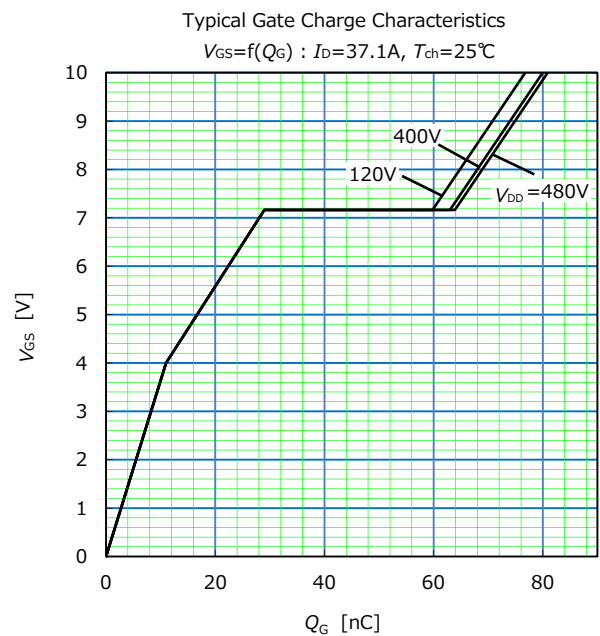
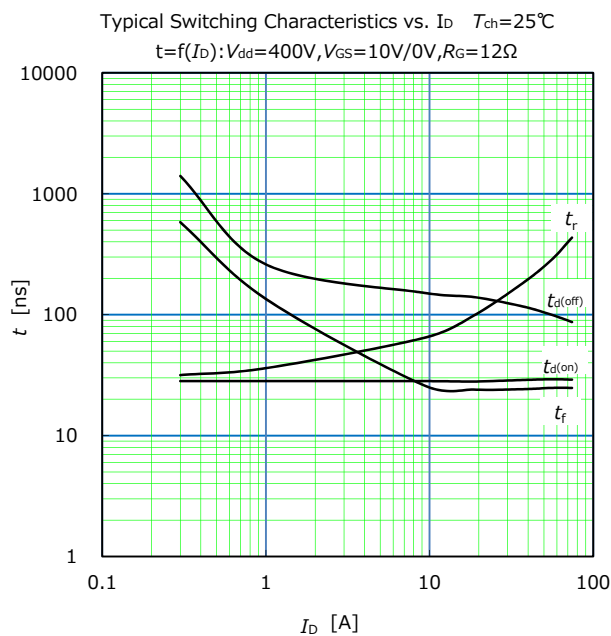
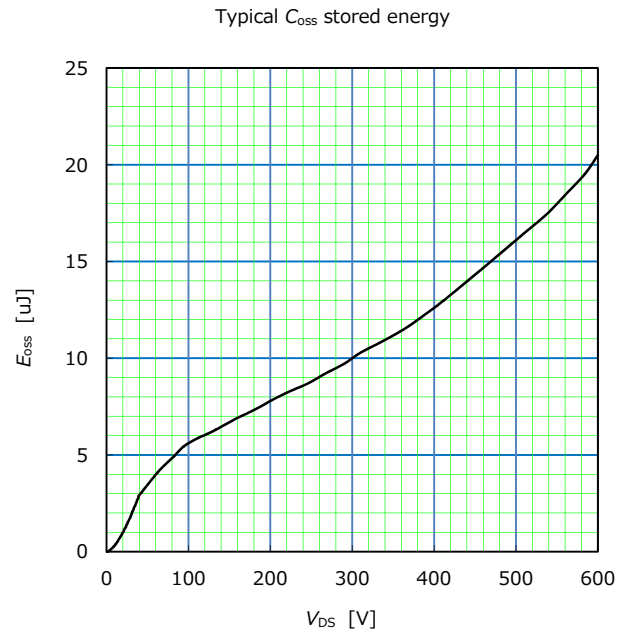
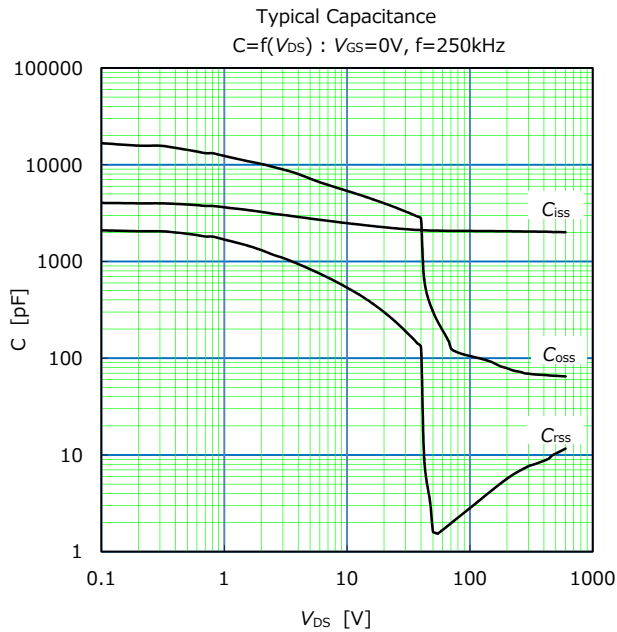
$$g_{fs} = f(I_D) : 80\mu\text{s pulse test}, V_{DS} = 25\text{V}$$



Typical Forward Characteristics of Reverse Diode

$$I_{SD} = f(V_{SD}) : 80\mu\text{s pulse test}$$





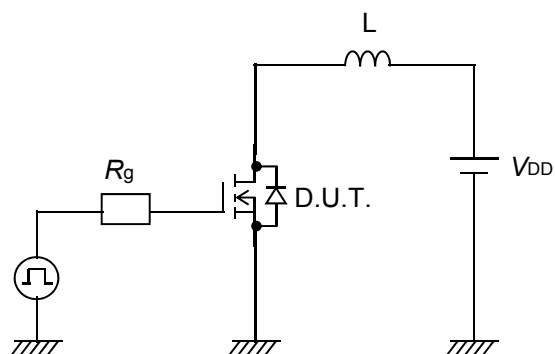


Fig.1 Avalanche Test circuit

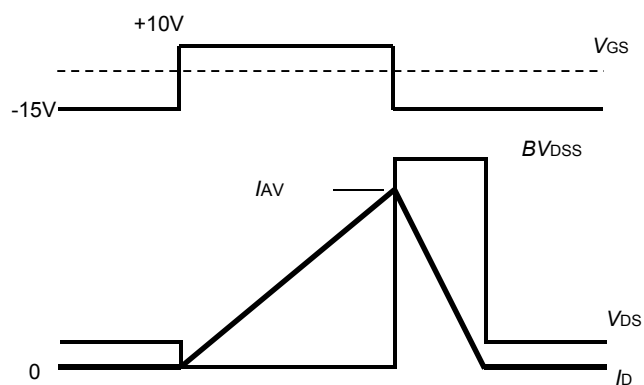


Fig.2 Operating waveforms of Avalanche Test

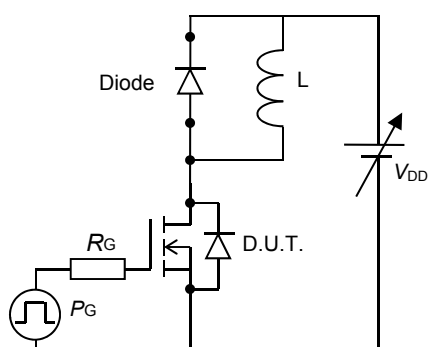


Fig.3 Switching Test circuit

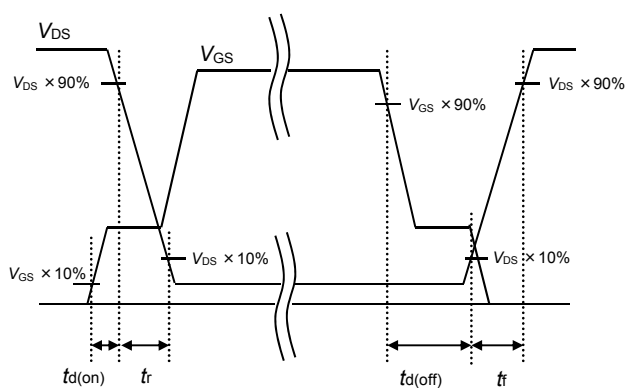


Fig.4 Operating waveform of Switching Test

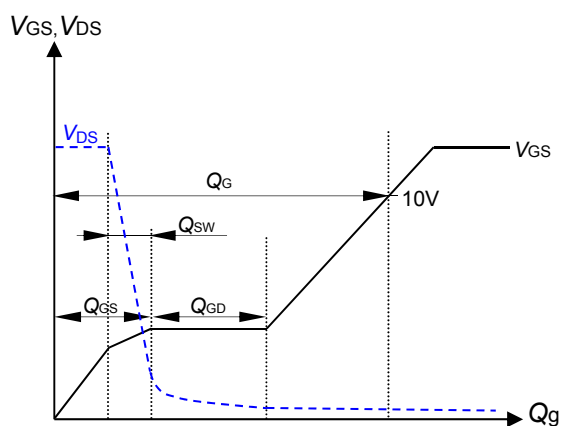


Fig.5 Operating waveform of Gate charge Test

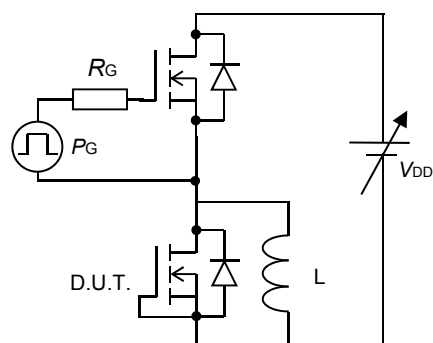


Fig.6 Reverse recovery Test circuit

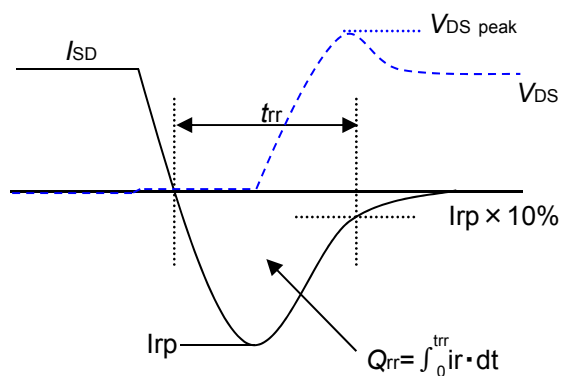
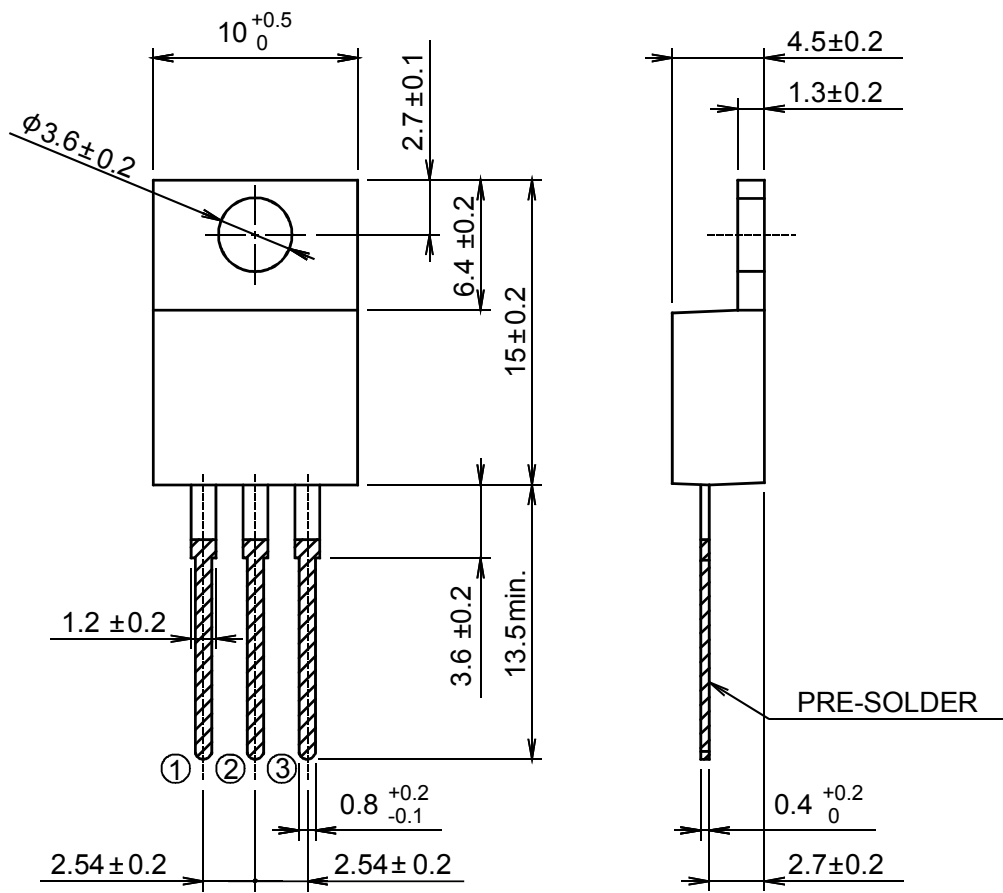
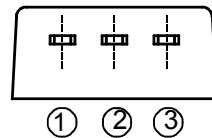


Fig.7 Operating waveform of Reverse recovery Test

■ Outview: TO-220 Package



CONNECTION

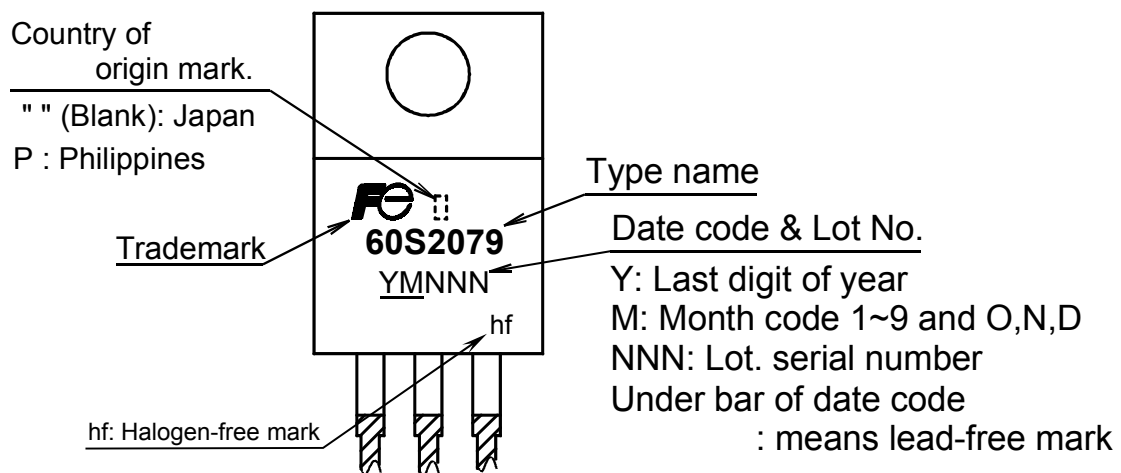


- ① GATE
- ② DRAIN
- ③ SOURCE

JEDEC : TO-220AB

DIMENSIONS ARE IN MILLIMETERS.

■ Marking



* The font (font type,size) and the trademark-size might be actually different.

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